# S29GL-S (Pb Package)

3 Volt-Only Flash Memory with Page Mode featuring 65 nm MirrorBit® Process Technology Device Documentation



Supplement

#### **General Description**

This supplementary document provides information on a device designed for limited distribution. It describes how the features, operation, and ordering options of this device have been enhanced or changed from the standard device on which it is based. The information contained in this document modifies any information on the same topics established by the data sheets listed in the Affected Documents/Related Documents table and should be used in conjunction with those documents. This document may also contain information that was not previously covered by the S29GL-S data sheet. It is intended for hardware system designers and software developers of applications, operating systems, or tools.

#### **Affected Documents/Related Documents**

Title	Publication Number	
S29GL-S MirrorBit Flash Family Data Sheet	S29GL_128S_01GS_00	



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### 1. Device Description

None.

## 2. Device Bus Operation Changed

None.

## 3. Embedded Algorithm Performance

None.

### 4. Electrical Specifications

None.

## 5. Timing Specifications

None.



#### **Ordering Information**

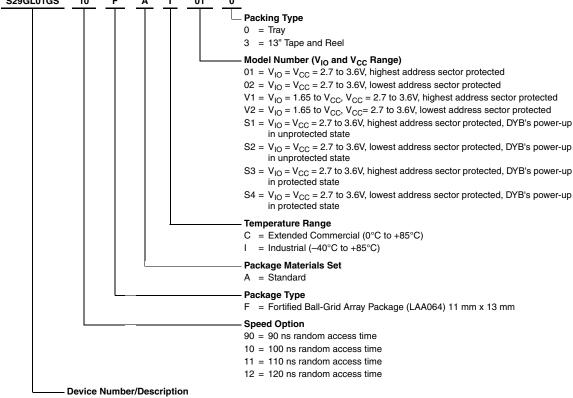
#### **Valid Combinations**

The Recommended Combinations table lists configurations planned to be available in volume. The table below will be updated as new combinations are released. Consult your local sales representative to confirm availability of specific combinations and to check on newly released combinations.

S29GL-S Valid Combinations								
Base OPN	Speed (ns)	Package and Temperature	Model Number	Packing Type	Ordering Part Number (yy = Model Number, x = Packing Type)			
S29GL01GS	- 100, 110	FAI (Note 1)	01, 02	0, 3 (Note 2)	S29GL01GS10FAlyyx			
					S29GL01GS11FAlyyx			
S29GL512S					S29GL512S10FAlyyx			
					S29GL512S11FAlyyx			
00001.0500	90, 100				S29GL256S10FAlyyx			
S29GL256S					S29GL256S90FAlyyx			
S29GL128S					S29GL128S10FAlyyx			
					S29GL128S90FAlyyx			

- 1. Additional speed, package, and temperature options maybe offered in the future. Check with your local sales representative for
- 2. Package Type 0 is standard option.

The ordering part number for the device is formed by a valid combination of the following:



S29GL01GS, S29GL512S, S29GL256S, S29GL128S

3.0 Volt Core, with VIO Option, 1024, 512, 256, 128 Megabit Page-Mode Flash Memory,

Manufactured on 65 nm MirrorBit Eclipse Process Technology



# 7. Revision History

Section	Description			
Revision 01 (October 21, 2011)				
	Initial release			
Revision 02 (December 14, 2011)				
Ordering Information	Updated Valid Combinations table			



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